TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

ULN2003AP, ULN2003AFW, ULN2004AP, ULN2004AFW

7CH DARLINGTON SINK DRIVER

The ULN2003AP/AFW Series are high-voltage, high-current darlington drivers comprised of seven NPN darlington pairs.

All units feature integral clamp diodes for switching inductive loads.

Applications include relay, hammer, lamp and display (LED) drivers.

FEATURES

- Output current (single output) 500 mA MAX.
- High sustaining voltage output
 50 V MIN. (ULN2003AP / AFW Series)
- Output clamp diodes

TYPE

ULN2003AP/AFW

ULN2004AP / AFW

• Inputs compatible with various types of logic

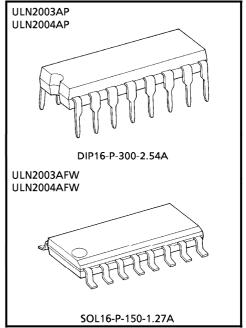
INPUT BASE

RESISTOR

 $2.7 \,\mathrm{k}\Omega$

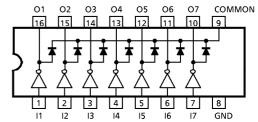
10.5 kΩ

- Package Type-AP : DIP-16pin
- Package Type-AFW : SOL-16pin



Weight DIP16-P-300-2.54A : 1.11 g (Typ.) SOL16-P-150-1.27A : 0.15 g (Typ.)

PIN CONNECTION (TOP VIEW)



980910EBA1

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DESIGNATION

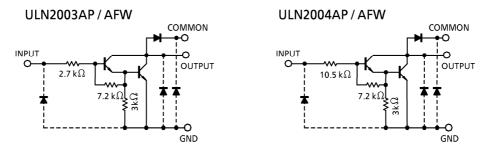
6~15 V PMOS, CMOS

TTL, 5 V CMOS

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1999-10-06 1/11

SCHEMATICS (EACH DRIVER)



(Note) : The input and output parasitic diodes cannot be used as clamp diodes.

MAXIMUM RATINGS (Ta = 25° C)								
CHARACTERIS	STIC	SYMBOL	RATING	UNIT				
Output Sustaining \	/oltage	V _{CE} (SUS)	-0.5~50	V				
Output Current		Ιουτ	500	mA / ch				
Input Voltage		VIN	- 0.5~30	V				
Clamp Diode Revers	e Voltage	V _R	50	V				
Clamp Diode Forward Current		١F	500	mA				
Deven Dissingsting	AP	D-	1.47	w				
Power Dissipation	AFW	PD	0.54/0.625 (Note)					
Operating Temperat	ture	T _{opr}	- 40~85	°C				
Storage Temperatur	e	T _{stg}	- 55~150	°C				

(Note) : On glass epoxy PCB ($30 \times 30 \times 1.6 \text{ mm}$ Cu 50%)

CHARACTER	ISTIC	SYMBOL	CONDITION		MIN.	TYP.	MAX.	UNIT
Output Sustaining	Voltage	V _{CE} (SUS)			0	—	50	V
Output Current AP		- Iout	$T_{pw} = 25 \text{ ms}$	Duty = 10%	0	_	370	
	AP		7 Circuits Ta = 85°C	Duty = 50%	0	—	130	mA / ch
	AFW			Duty = 10%	0	—	233	
			T _j = 120°C	Duty = 50%	0	—	70	
Input Voltage		V _{IN}			0	_	24	v
Input Voltage	ULN2003A	M	I _{OUT} = 400 mA		2.8	_	24	V
(Output On)	ULN2004A	VIN (ON)	h _{FE} = 800		6.2	_	24	v
Input Voltage	ULN2003A				0		0.7	v
(Output Off)	ULN2004A	VIN (OFF)			0	—	1.0	v
Clamp Diode Reverse Voltage		VR			—	—	50	V
Clamp Diode Forward Current		١ _F			_	_	350	mA
	AP	D-	Ta = 85°C — —		_	0.76	w	
Power Dissipation	AFW	PD	(Note) Ta = 85°C		_	_	0.325	vv

RECOMMENDED OPERATING CONDITIONS (Ta = $-40 \sim 85^{\circ}$ C)

(Note) : On glass epoxy PCB ($30 \times 30 \times 1.6 \text{ mm}$ Cu 50%)

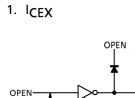
CHARACTER	ISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Output Leakage Current		ICEX	1	V _{CE} = 50 V, Ta = 25°C		—	—	50	μA
				V _{CE} = 50 V, Ta = 85°C			—	100	μη
Collector-Emitter Saturation Voltage		V _{CE} (sat)	2	$I_{OUT} = 350 \text{ mA}, I_{IN} = 500 \mu\text{A}$		—	1.3	1.6	v
					I_{OUT} = 200 mA, I_{IN} = 350 μ A		1.1	1.3	
					mA, I _{IN} = 250 μA		0.9	1.1	
DC Current Transfe	r Ratio	h _{FE}	2	V _{CE} = 2 V, I _{OUT} = 350 mA		1000	_	—	
Input Current	ULN2003A			V _{IN} = 2.4 V,	l _{OUT} = 350 mA	—	0.4	0.7	
(Output On)	ULN2004A			V _{IN} = 9.5 V, I _{OUT} = 350 mA		_	0.8	1.2	mA
Input Current (Output Off)		^I IN (OFF)	4	l _{OUT} = 500 μA, Ta = 85°C		50	65	—	μA
Input Voltage (Output On)	ULN2003A	VIN (ON)			l _{OUT} = 350 mA		2.6		
			5	V _{CE} = 2 V h _{FE} = 800	l _{OUT} = 200 mA	_	_	2.0	- v
	ULN2004A				I _{OUT} = 350 mA		—	4.7	
					I _{OUT} = 200 mA	—	—	4.4	
Clamp Diode Reverse Current		IR	6	V _R = 50 V, Ta = 25°C		—	—	50	
				V _R = 50 V, Ta = 85°C		—	—	100	μΑ
Clamp Diode Forward Voltage		VF	7	I _F = 350 mA		—	—	2.0	V
Input Capacitance		C _{IN}					15	—	рF
Turn-On Delay		^t ON	8	V_{OUT} = 50 V, R _L = 125 Ω C _L = 15 pF		_	0.1	_	
Turn-Off Delay		^t OFF	8	V_{OUT} = 50 V, R _L = 125 Ω C _L = 15 pF		_	0.2	_	μs

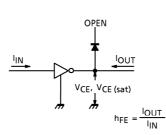
ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

TEST CIRCUIT

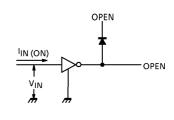
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2. V_{CE (sat)}, h_{FE}

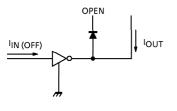


3. IIN (ON)

6. I_R

4. IIN (OFF)

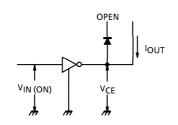


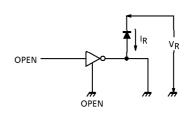


^ICEX

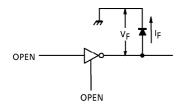
VCE

Å



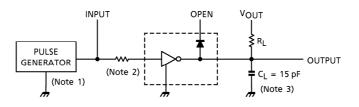


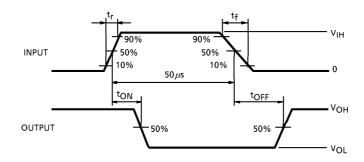
7. V_F



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8. t_{ON}, t_{OFF}





- (Note 2) : See below

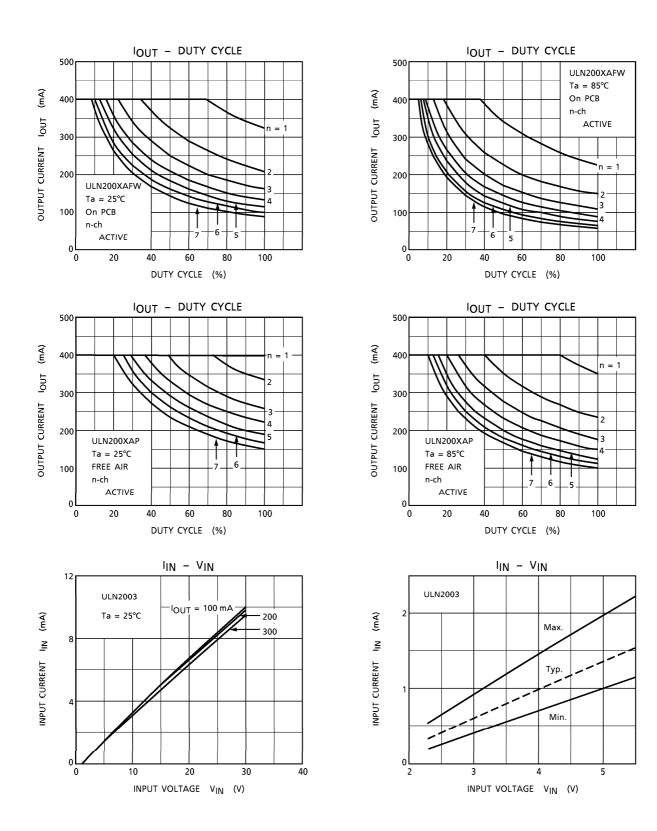
INPUT CONDITION

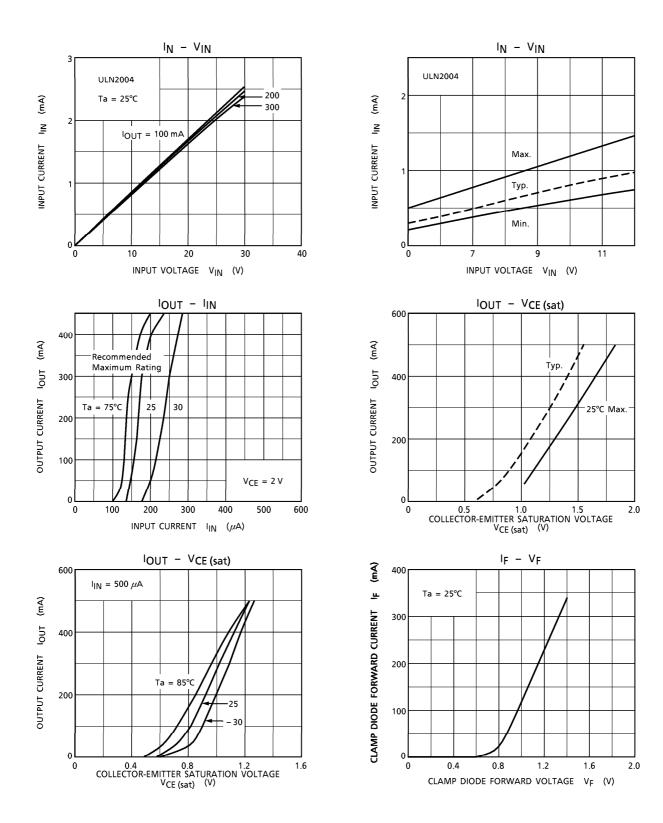
TYPE NUMBER	R1	V _{IH}
ULN2003AP / AFW	0	3 V
ULN2004AP / AFW	0	8 V

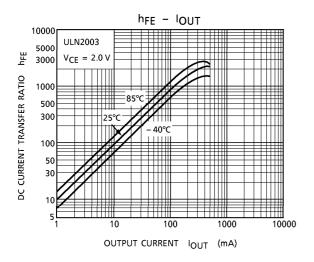
(Note 3) : C_L includes probe and jig capacitance.

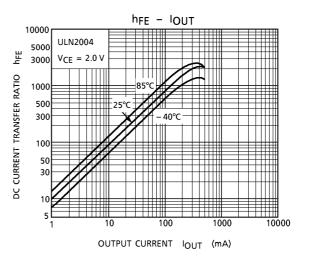
PRECAUTIONS for USING

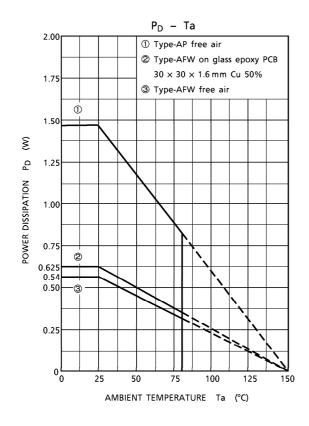
Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.





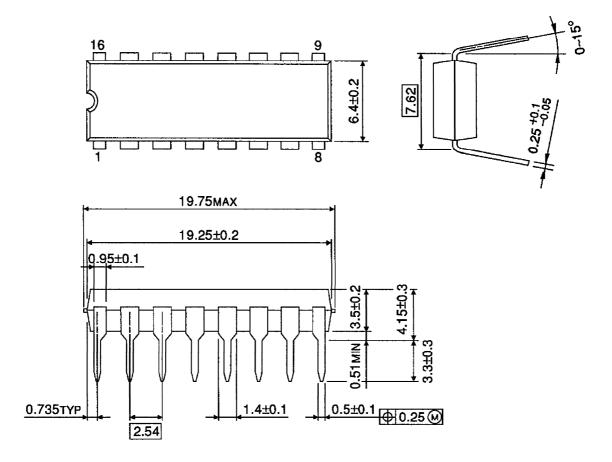






OUTLINE DRAWING

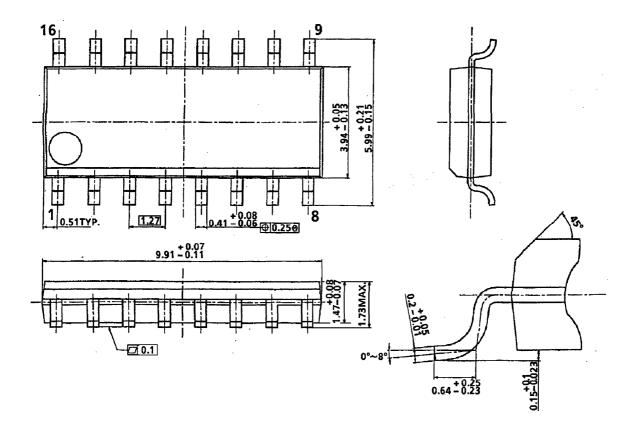
DIP16-P-300-2.54A



Weight : 1.11 g (Typ.)

OUTLINE DRAWING

SOL16-P-150-1.27A



Weight: 0.15 g (Typ.)